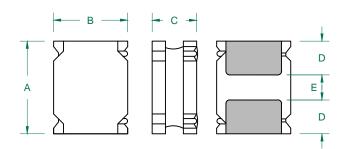
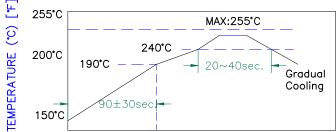
TYS252010L6R8M-10

PHYSICAL DIMENSIONS:

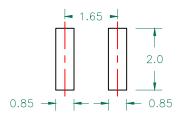
Α	2.50	±	0.10
В	2.00	±	0.10
С	1.00		MAX.
D	0.80	±	0.20
Ε	0.80	±	0.20

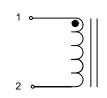


RECOMMENDED SOLDERING CONDITIONS



LAND PATTERNS FOR REFLOW SOLDERING



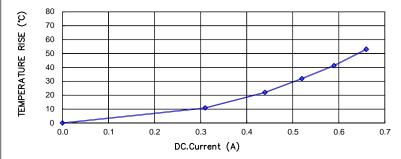




ELECTRICAL SPECIFICATION

	Min	Тур	Max
INDUCTANCE (uH) L @ 100KHz/1V ± 20%	5.44	6.80	8.16
DCR (Ω)			0.896
Saturation Current(A)		0.92	0.78

CHARACTERISTICS OF TEMPERATURE RISE



UNCONTROLLED DOCUMENT

SRF (MHz)	32	
Temperature Rise		
Current (A)	0.59	

NOTES: UNLESS OTHERWISE SPECIFIED

1.OPERATING TEMPERATURE RANGE: -40°C TO +125°C (INCLUDING SELF-HEATING) .

2.STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)

3.UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS: A. AMBIENT TEMPERATURE: 20±15°C.

B. RELATIVE HUMIDITY: 65%±20%.

4.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS \leq 30% FROM ITS VALUE WITHOUT CURRENT.

5.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40\,^{\circ}\!\text{C}$) FROM 20°C AMBIENT.

	DIMENSIONS ARE IN mm .			This print is the property of Laird			
				Tech. and is loaned in confidence subject to return upon request an with the understanding that no copies shall be mode without the written consent of Laird Tech. All rights to design or invention are reserved.	l I	_air	ď
				PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:
				TYS252010L6R8M-10	В	POWER INDUCTOR	QIU
В	CHANGE TEMP FROM -25°C~+125°C	12/27/12	QIU	DATE: 07/06/12	ALE: N	TS SHEET:	- 1
Α	ORIGINAL DRAFT	07/06/12	QIU		OL #	13 .	
REV	DESCRIPTION	DATE	INT		· ,	- 1	of 1

CURRENT VS INDUCTANCE DROP IN RATES

